



## APPROVAL SHEET

### Customer Information

Customer :			
Part Name :			
Part No. :			
Model No. :			
	COMPANY	PURCHASE	R&D



### Vendor Information

Name:	SFI ELECTRONICS TECHNOLOGY INC.
Part Name	Semiconductor TVS Device
Part No.	SFI0402TS050-100A-11
Lot No.	

### SFI ELECTRONICS TECHNOLOGY INC.

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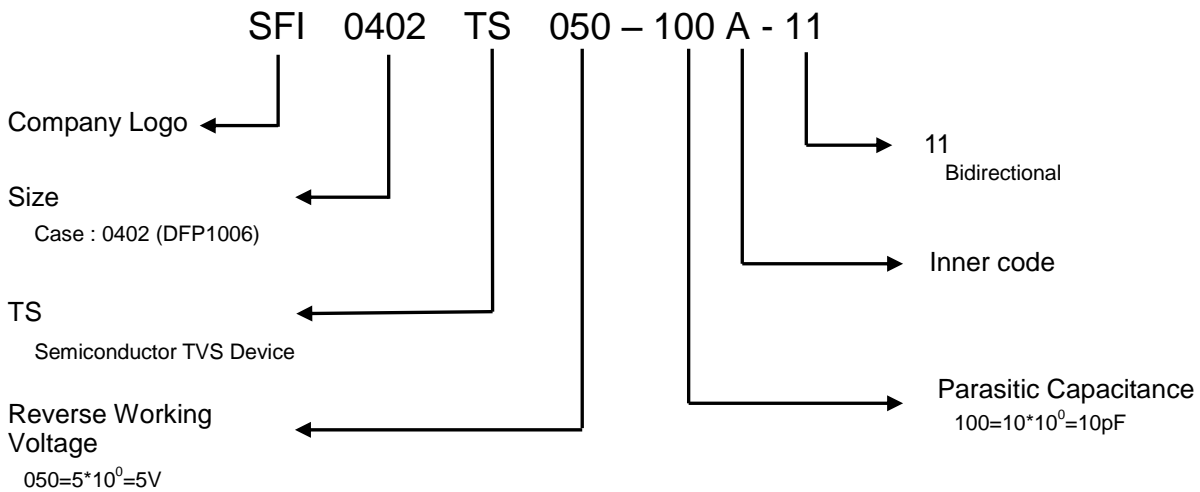
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Quality Control	Document Control	Business Issue	
 <p>ISO 9001:2008 ISO 14001:2004 ISO/TS 16949:2009 Management System www.tuv.com ID 1100008833</p>	REV : B	Prepared	Check
			

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## 1. Part Number Identification



### 1.1 Features

- (1) Transient protection for high-speed data lines  
IEC 61000-4-2 (ESD)  $\pm 30kV$  (Air)  
 $\pm 30kV$  (Contact)  
IEC 61000-4-4 (EFT) 40A (5/50 ns)  
Cable Discharge Event (CDE)
- (2) Package optimized for high-speed lines
- (3) Ultra-small package (1.0mm×0.5mm×0.5mm)
- (4) Protects one data, controller, power line
- (5) Capacitance: 10pF (Typical)
- (6) Low leakage current: 1nA @  $V_{RWM}$  (Typical)
- (7) Low clamping voltage
- (8) Each I/O pin can withstand over 1000 ESD strikes for  $\pm 8kV$  contact discharge

### 1.2 Description

SFI0402TS050-100A-11 is a low-capacitance Transient Voltage Suppressor (TVS) designed to provide electrostatic discharge (ESD) protection for data, control or power lines. With typical capacitance of 10pF only, SFI0402TS050-100A-11 is designed to protect parasitic-sensitive systems against over-voltage and over-current transient events. It complies with IEC 61000-4-2(ESD), Level 4 ( $\pm 30kV$  air,  $\pm 30kV$  contact discharge), IEC 61000-4-4 (electrical fast transient -EFT) (40A, 5/50 ns), very fast charged device model (CDM) ESD and cable discharge event (CDE), etc.

SFI0402TS050-100A-11 uses ultra-small 0402 (DFP1006) package. Each SFI0402TS050-100A-11 device can protect one data line. It offers system designers flexibility to protect single data line where space is a premium concern.

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### 1.3 Applications

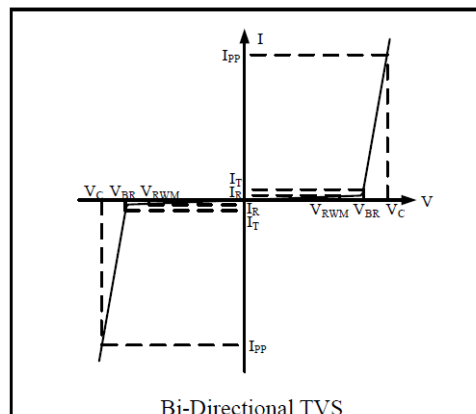
- (1) Portable Electronics
- (2) Desktops, Servers and Notebooks
- (3) Cellular Phones
- (4) MP3 Ports
- (5) Digital Camera Ports
- (6) Subscriber Identity Module (SIM) card

### 1.4 Absolute Maximum Ratings (Ta=25°C)

ITEM	Symbol	Rating	Unit
Peak pulse power (tp = 8/20us)	$P_{PK}$	96	W
Peak pulse current (tp = 8/20us)	$I_{PP}$	8	A
ESD per IEC 61000-4-2 (Air)	$V_{ESD}$	±30	KV
ESD per IEC 61000-4-2 (Contact)	$V_{ESD}$	±30	KV
Operating Temperature Range	$T_{OPT}$	-55 to 125	°C
Storage Temperature Range	$T_{STG}$	-55 to 150	°C

### 1.5 Electrical characteristics (Ta=25°C)

Symbol	Parameter
$V_{RWM}$	Nominal Reverse Working Voltage
$I_R$	Reverse Leakage Current @ $V_{RWM}$
$V_{BR}$	Reverse Breakdown Voltage @ $I_T$
$I_T$	Test Current for Reverse Breakdown
$V_C$	Clamping Voltage @ $I_{PP}$
$I_{PP}$	Maximum Peak Pulse Current
$C_{ESD}$	Parasitic Capacitance
$V_R$	Reverse Voltage
f	Small Signal Frequency



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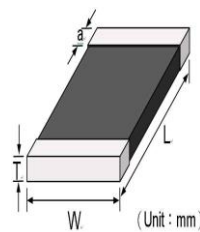


ITEM	Symbol	SFI0402TS050-100A-11	Unit
Working Peak Reverse Voltage	$V_{RWM}$	5.0	V
Maximum Reverse Leakage (@ $V_{RWM}$ , 25°C) (Between I/O_1 and I/O_2)	IR	Typ. 0.001 (Max. 0.08)	$\mu$ A
Breakdown Voltage (@ $I_T=1$ mA) (Between I/O_1 and I/O_2)	VBR	Typ. 7.5 (Min. 5.2 Max. 9.8)	V
Clamping voltage (@ $I_{PP}=16$ A, $t_p=100$ ns)	$V_{CL}$	12	V
Clamping voltage (@ $V_{ESD} = 8$ kV)	$V_{CL}$	12	V
Maximum Clamping Voltage (@ $I_{PP}=1$ A, $t_p=8/20\mu$ s) (Between I/O_1 and I/O_2)	VC	Max. 8	V
Maximum Clamping Voltage (@ $I_{PP}=8$ A, $t_p=8/20\mu$ s) (Between I/O_1 and I/O_2)	VC	Max. 12	V
Parasitic Capacitance (@ $V_R=0$ V, $f=1$ MHz) (Between I/O_1 and I/O_2)	CESD	Typ. 10	pF

## 2. Mechanical Characteristics

- (1) Case : 0402 (DFP1006 package)
- (2) Flammability Rating: UL 94V-0
- (3) Packaging: Tape and Reel
- (4) Polarity : Bidirectional

Model	0402 (DFP1006)
Length(L)	1.00 $\pm$ 0.05
Width(W)	0.50 $\pm$ 0.05
Thickness(T)	0.50 $\pm$ 0.05
Termination(a)	0.25 $\pm$ 0.1

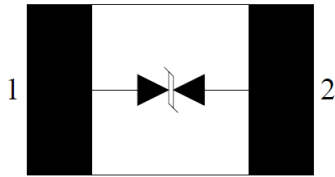


### 2.1 Circuit Diagram



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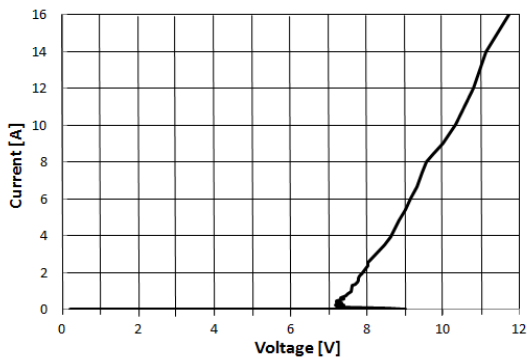
### 2.2 Pin Configuration



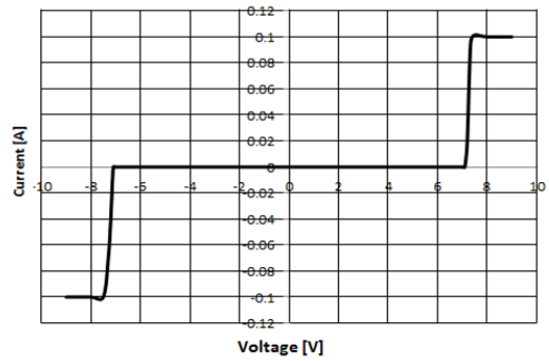
0402 (DFP1006)  
(TOP View)

### 3. Rating and Characteristic Curves

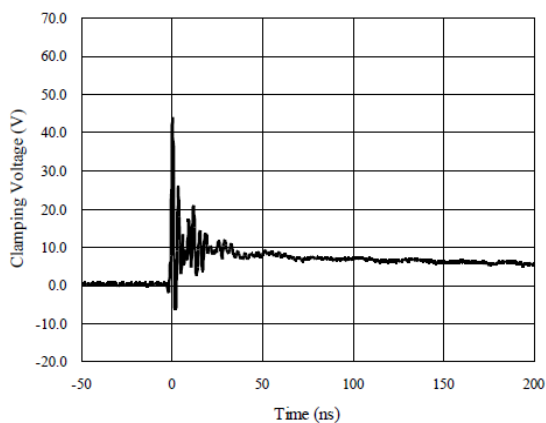
TLP Measurement



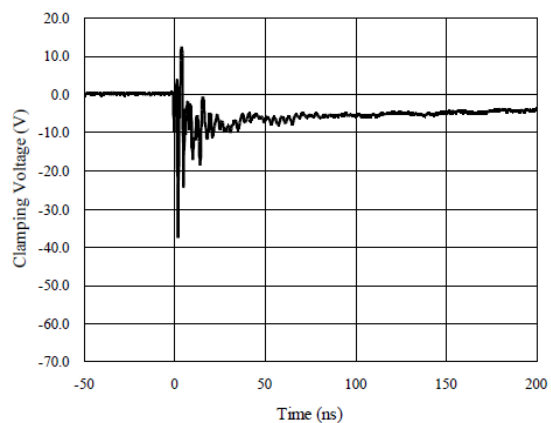
Voltage Sweeping of I/O\_1 to I/O\_2



ESD Clamping of I/O\_1 to I/O\_2  
(+8kV Contact per IEC 61000-4-2)



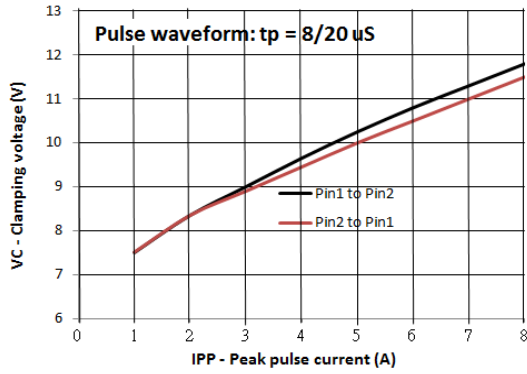
ESD Clamping of I/O\_1 to I/O\_2  
(-8kV Contact per IEC 61000-4-2)



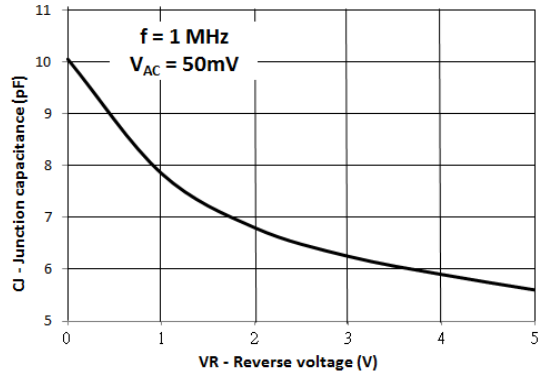
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### Clamping Voltage vs. Peak Pulse Current



### Capacitance vs. Reverse voltage



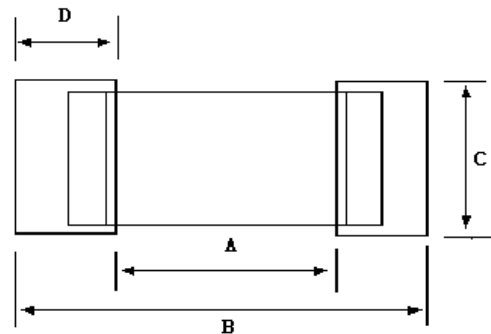
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### 4. Recommended solder pad layout

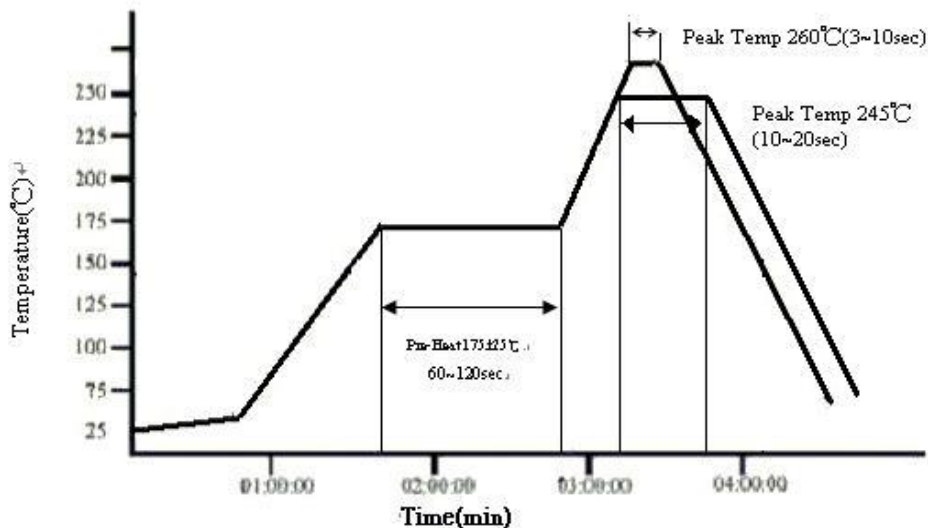
#### 4.1 Recommended solder pad layout

(Unit : mm)

	A	B	C	D
0402	0.4~0.6	1.4~1.8	0.5~0.6	0.4~0.7



#### 4.2 The IR reflow and temperature of Soldering for Pb Free



#### ☆ IR reflow Pb Free Process suggestion profile

- (1) The solder recommend is Sn96.5/Ag 3.5 of 120 to 150  $\mu$  m
- (2) Ramp-up rate (217°C to Peak) + 3°C/second max
- (3) Temp. maintain at 175 +/-25°C 180 seconds max
- (4) Temp. maintain above 217 °C 60-150 seconds
- (5) Peak temperature range 245°C +20°C/ -10 °C time within 5 °C of actually peak temperature (tp) 10~20 seconds
- (6) Ramp down rate +6 °C/second max.

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### 4.3 Hand Soldering

In hand soldering of the STS Devices. Large temperature gradient between preheated the STS Devices and the tip of soldering iron may cause electrical failures and mechanical damages such as crackings or breakings of the devices. The soldering shall be carefully controlled and carried out so that the temperature gradient is kept minimum with following recommended conditions for hand soldering.

#### 4.3.1 Recommended Soldering Condition 1

- (1) Solder :  
**0.12~0.18mm** Thread solder (Sn96.5:Ag3.5) with soldering flux in the core.  
Rosin-based and non-activated flux is recommended.
- (2) Preheating  
The STS Devices shall be preheated so that Temperature Gradient between the devices and the tip of soldering iron is 150°C or below.
- (3) Soldering Iron  
Rated Power of 20w max with 3mm soldering tip in diameter.  
Temperature of soldering iron tip **300°C max, 3-5sec** ( The required amount of solder shall be melted in advance on the soldering tip.)
- (4) Cooling  
After soldering. The STS Devices shall be cooled gradually at room ambient temperature.

#### 4.3.2 Recommended Soldering Condition 2 ( Without preheating )

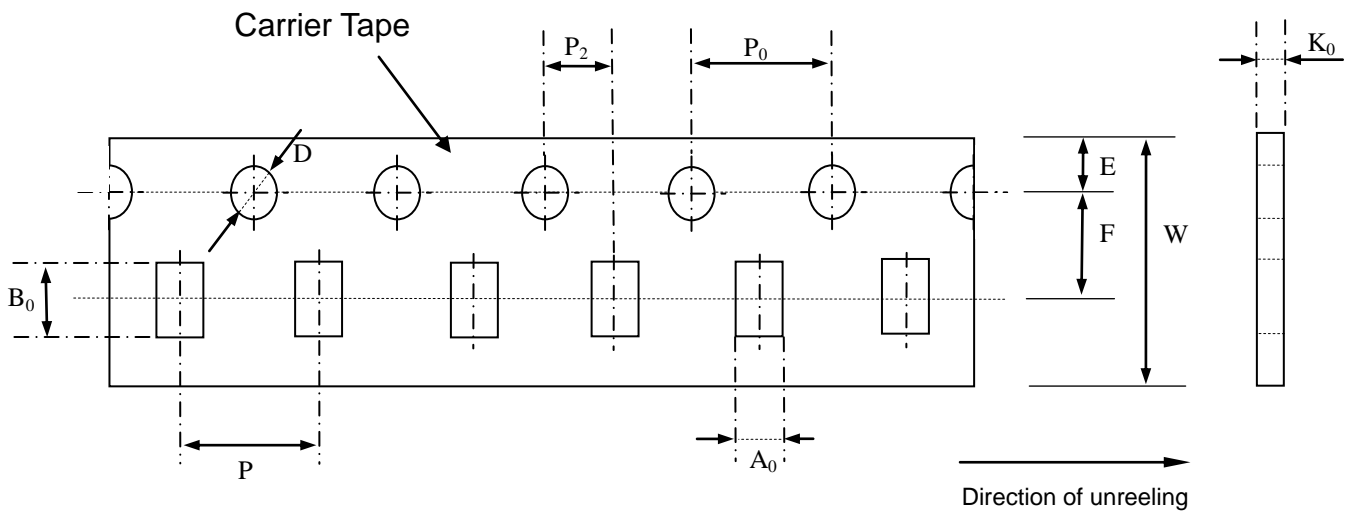
- (1) Temperature of soldering iron tip **300°C max, 3-5sec**.
- (2) Solder iron tip shall not directly touch to STS Devices.
- (3) Solder iron tip shall be fully preheated before soldering while soldering iron tip to the external electrode of STS Devices.

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### 5. Packaging Specification

- 5.1 Carrier tape and transparent cover tape should be heat-sealed to carry the products, and the reel should be used to reel the carrier tape.
- 5.2 The adhesion of the heat-sealed cover tape shall be  $40 + 20 / - 15$ grams.
- 5.3 Both the head and the end portion of the taping shall be empty for reel package and SMT auto-pickup machine. And a normal paper tape shall be connected in the head of taping for the operator to handle.

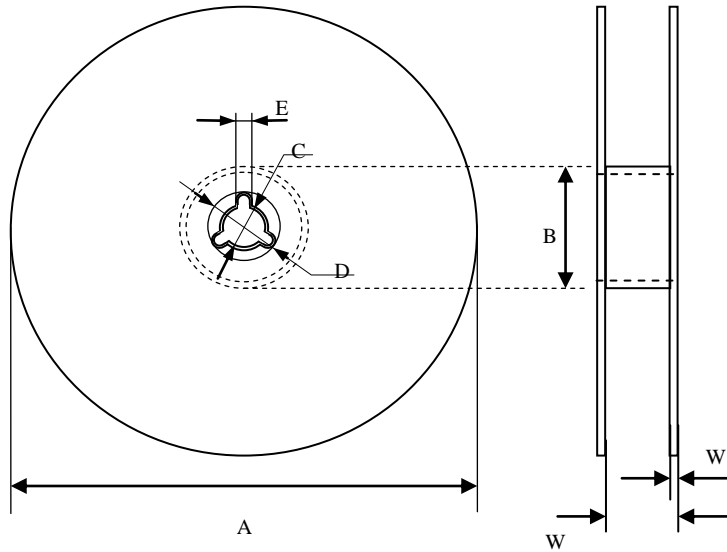


Symbol	$A_0$ $\pm 0.05$	$B_0$ $\pm 0.05$	$K_0$ $\pm 0.05$	$D$ $+0.10$ $-0.05$	$P$ $\pm 0.10$	$P_2$ $\pm 0.10$	$P_0$ $\pm 0.10$	$W$ $\pm 0.10$	$E$ $\pm 0.10$	$F$ $\pm 0.05$
<b>0402</b>	0.62	1.12	0.60	1.55	2.00	2.00	4.00	8.00	1.75	3.50

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## 6. Reel Dimension



Symbol	A	B	C	D	E	W	W <sub>1</sub>
0402	178.0±1.0	60.0±0.5	13.0±0.2	21.0±0.2	2.0±0.5	9.0±0.50	1.5±0.15

## 7. Ordering Information

Part Number	Working Voltage	Quantity	Reel Size
SFI0402TS050-100A-11	5V	10000	7 Inch

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